Quad TTL/NMOS to PECL* Translator

Description

The MC10H351 is a quad translator for interfacing data between a saturated logic section and the PECL section of digital systems when only a +5.0 Vdc power supply is available. The MC10H351 has TTL/NMOS compatible inputs and PECL complementary open-emitter outputs that allow use as an inverting/non-inverting translator or as a differential line driver. When the common strobe input is at a low logic level, it forces all true outputs to the PECL low logic state (\approx +3.2 V) and all inverting outputs to the PECL high logic state (\approx +4.1 V).

The MC10H351 can also be used with the MC10H350 to transmit and receive TTL/NMOS information differentially via balanced twisted pair lines.

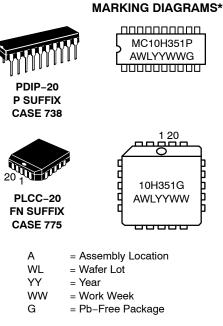
Features

- Single +5.0 Power Supply
- All V_{CC} Pins Isolated On Chip
- Differentially Drive Balanced Lines
- $t_{pd} = 1.3$ nsec Typical
- Pb-Free Packages are Available*



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*For additional marking information, refer to Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

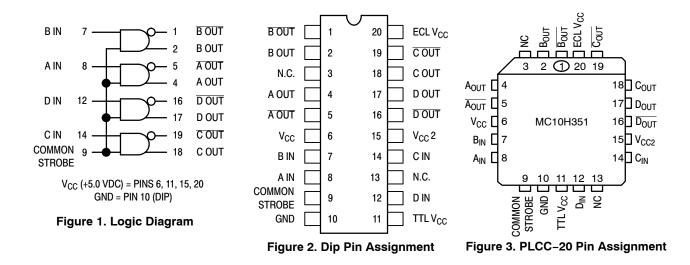


Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V _{CC}	Power Supply	0 to +7.0	Vdc
VI	Input Voltage (V _{CC} = 5.0 V)	0 to V _{CC}	Vdc
l _{out}	Output Current – Continuous – Surge	50 100	mA
T _A	Operating Temperature Range	0 to +75	°C
T _{stg}	Storage Temperature Range – Plastic	–55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

	Characteristic		0 °		25 °		75 °	
Symbol		Min	Max	Min	Max	Min	Max	Unit
ECL	Power Supply Current	-	50	-	45	-	50	mA
TTL		_	20	-	15	-	20	mA
I _R I _{INH}	Reverse Current Pins 7, 8, 12, 14 Pin 9		25 100		20 80		25 100	μΑ
I _F I _{INL}	Forward Current Pins 7, 8, 12, 14 Pin 9		-0.8 -3.2		-0.6 -2.4		-0.8 -3.2	mA
V _{(BR)in}	Input Breakdown Voltage	5.5	_	5.5	-	5.5	-	Vdc
VI	Input Clamp Voltage (I _{in} = -18 mA)	-	-1.5	-	-1.5	-	-1.5	Vdc
V _{OH}	High Output Voltage (Note 1.)	3.98	4.16	4.02	4.19	4.08	4.27	Vdc
V _{OL}	Low Output Voltage (1)	3.05	3.37	3.05	3.37	3.05	3.37	Vdc
V_{IH}	High Input Voltage	2.0	-	2.0	-	2.0	-	Vdc
VIL	Low Input Voltage	-	0.8	_	0.8	-	0.8	Vdd

Table 2. ELECTRICAL CHARACTERISTICS (V_{CC} = V_{CC1} = V_{CC2} = $5.0 \text{ V} \pm 5.0\%$)†

†Each MECL 10H[™] series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to V_{CC} –2.0 Vdc.

*Positive Emitter Coupled Logic

1. With V_{CC} at 5.0 V. V_{OH}/V_{OL} change 1:1 with V_{CC}.

Table 3. AC PARAMETERS

		0° 25°		5°	75 °			
Symbol	Characteristic	Min	Мах	Min	Max	Min	Max	Unit
t _{pd}	Propagation Delay (Note 2)	0.4	2.2	0.4	2.2	0.4	2.1	ns
t _r	Rise Time (20% to 80%)	0.4	1.9	0.4	2.0	0.4	2.1	ns
t _f	Fall Time (80% to 20%)	0.4	1.9	0.4	2.0	0.4	2.1	ns
f _{max}	Maximum Operating Frequency	150	-	150	-	150	-	MHz

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Propagation delay is measured on this circuit from +1.5 V on the input waveform to the 50% point on the output waveform.

ORDERING INFORMATION

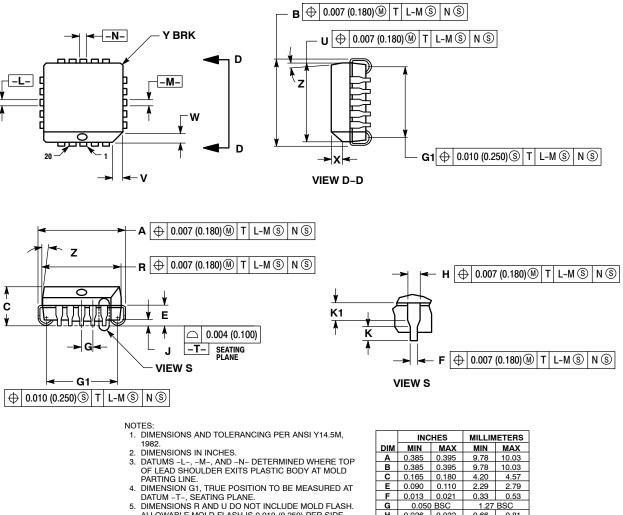
Device	Package	Shipping [†]		
MC10H351FNG	PLCC-20 (Pb-Free)	46 Units / Rail		
MC10H351FNR2G	PLCC-20 (Pb-Free)	500 / Tape & Reel		
MC10H351P	PDIP-20	18 Unit / Rail		
MC10H351PG	PDIP-20 (Pb-Free)	18 Unit / Rail		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



CASE 775-02 ISSUE F

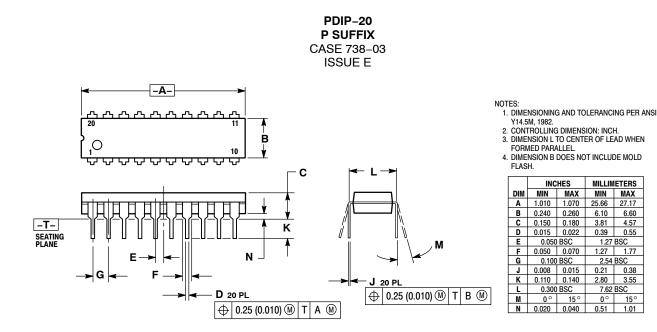


OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
DIMENSIONS IN THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300) DIMENSIONS TAND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, THE BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
DIMENSION HTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.

DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

DIM	MIN MAX		MIN	MAX	
Α	0.385	0.395	9.78	10.03	
В	0.385	0.395	9.78	10.03	
С	0.165	0.180	4.20	4.57	
E	0.090	0.110	2.29	2.79	
F	0.013	0.021	0.33	0.53	
G	0.050 BSC		1.27 BSC		
н	0.026	0.032	0.66	0.81	
J	0.020		0.51		
К	0.025		0.64		
R	0.350	0.356	8.89	9.04	
U	0.350	0.356	8.89	9.04	
v	0.042	0.048	1.07	1.21	
w	0.042	0.048	1.07	1.21	
X	0.042	0.056	1.07	1.42	
Y		0.020		0.50	
Z	2 °	10 °	2 °	10 °	
G1	0.310	0.330	7.88	8.38	
K1	0.040		1.02		

PACKAGE DIMENSIONS



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